

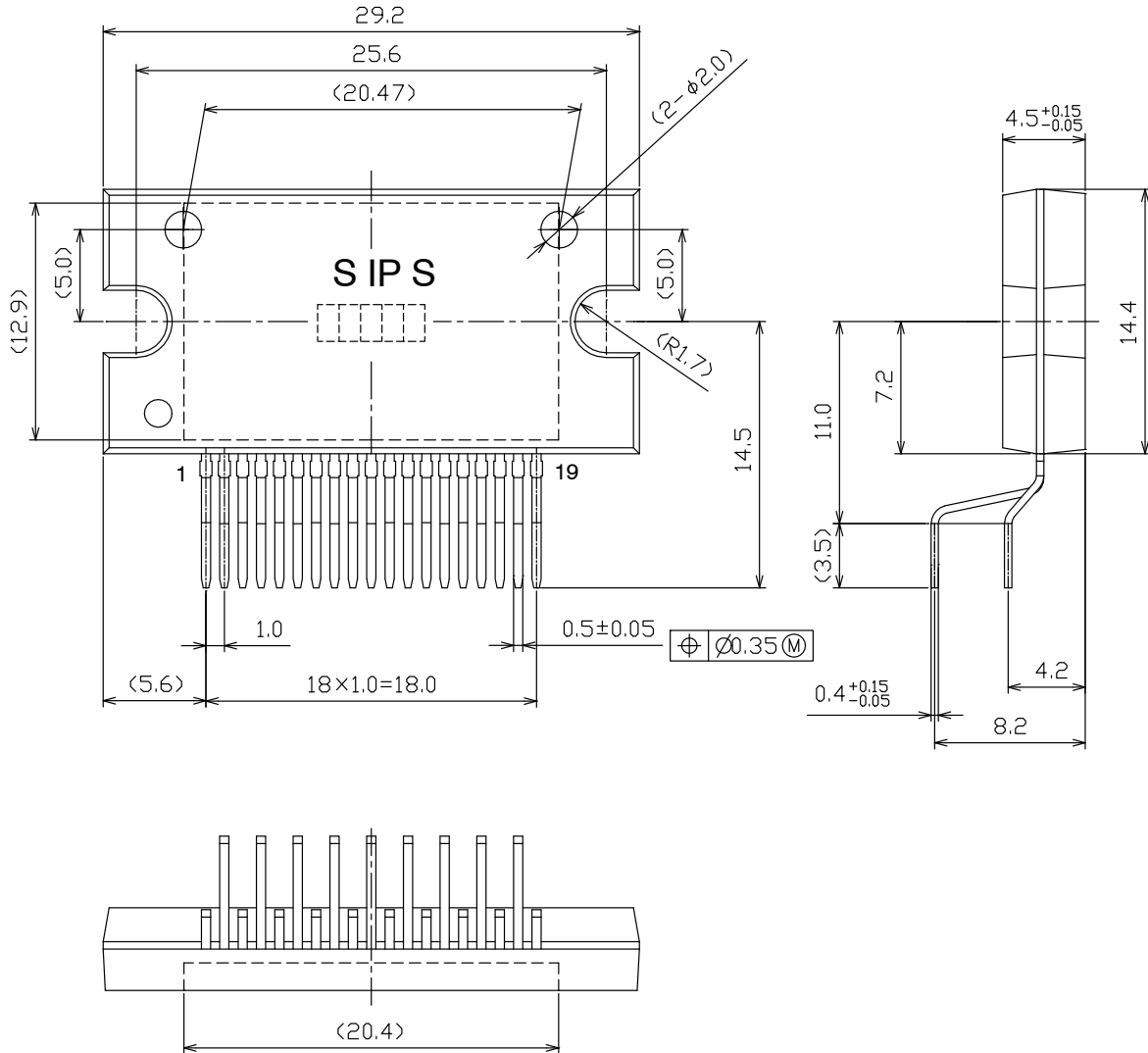
MECHANICAL CASE OUTLINE
PACKAGE DIMENSIONS

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SIP19 29.2x14.4
CASE 127CF
ISSUE O

DATE 30 APR 2012



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